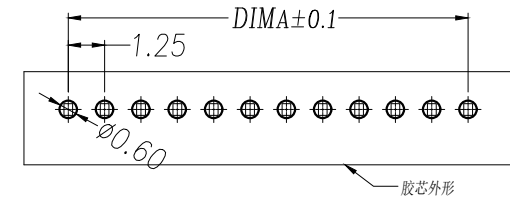
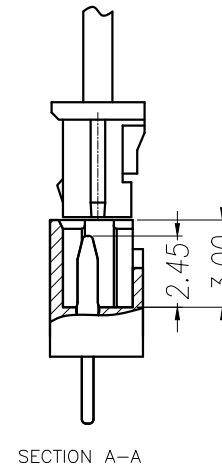
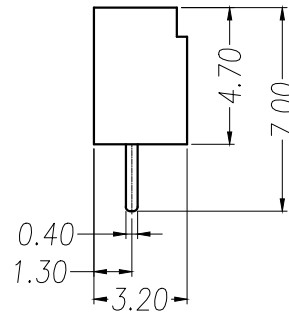
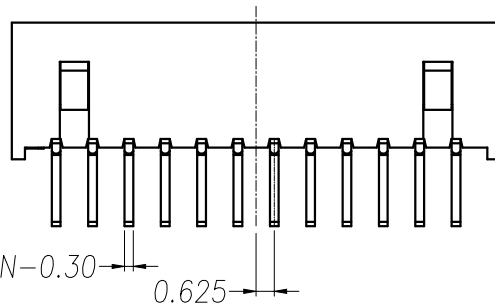
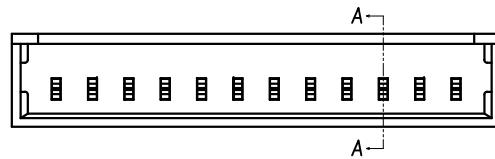
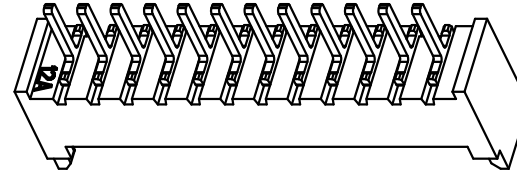
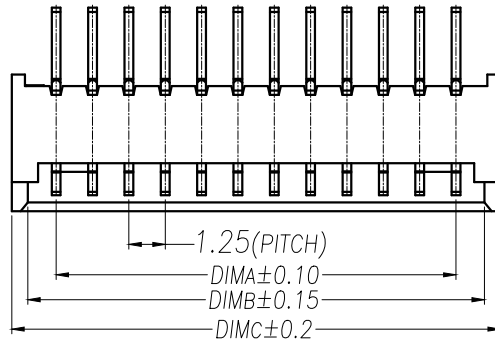


PRELIMINARY
DESIGN IS SUBJECT
TO CHANGE WITHOUT
PRIOR NOTICE

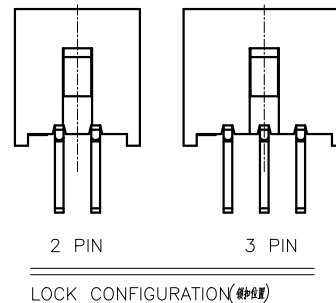
NOTES:

- 1.Working temp:-25°C~85°C.
- 2.Voltage rating:125V AC/DC(rms)
- 3.Contact resistance:55mΩ max.
- 4.Insulation resistance:100MΩ min.
- 5.Current rating:1A AV/DC
- 6.Withstanding Voltage:500V AC/minute
- 7.Pin Retention Force:5N min.
- 8.Housing material:LCP UL94-V0,Natural
- 9.Terminal materl:Brass,
plating Ni 40u" min , plating Tin 100u"min.
- 10.Solder tab material:Brass,
plating Ni 40u" min , plating Tin 100u"min.



RECOMMENDED PCB LAYOUT TOP VIEW (TOLERANCE:±0.05)

PIN	NO.	Dim A	Dim B	Dim C
2	XY-MX1.25-2PZZ	1.25	3.20	4.30
3	XY-MX1.25-3PZZ	2.50	4.45	5.55
4	XY-MX1.25-4PZZ	3.75	5.70	6.80
5	XY-MX1.25-5PZZ	5.00	6.95	8.05
6	XY-MX1.25-6PZZ	6.25	8.20	9.30
7	XY-MX1.25-7PZZ	7.50	9.45	10.55
8	XY-MX1.25-8PZZ	8.75	10.70	11.80
9	XY-MX1.25-9PZZ	10.00	11.95	13.05
10	XY-MX1.25-10PZZ	11.25	13.20	14.30
11	XY-MX1.25-11PZZ	12.50	14.45	15.55
12	XY-MX1.25-12PZZ	13.75	15.70	16.80
13	XY-MX1.25-13PZZ	15.00	16.95	18.05
14	XY-MX1.25-14PZZ	16.25	18.20	19.30
15	XY-MX1.25-15PZZ	17.50	19.45	20.55
16	XY-MX1.25-16PZZ	18.75	20.70	21.80



DIMENSION IN mm		厦门市辛译精密电子有限公司 Xiamen XinYi Xyconn Electronics Co.,Ltd			
TOLERANCE UNLESS OTHERWISE SPECIFIED		APR.	Alex	TITLE: WAFER 1.25mm H4.7mm 180°DIP	
.X±0.35	.X*±5°	CHK.	Jack	DWG NO. XY-MX1.25-NPZZ	
.XX±0.25	.X*±3°	DRA.	Can	PROJ.	CUSTOMER DRAWING
.XXX±0.15	.XX*±1°	SIZE A4	SCALE 1:1	SHEET 1/1	REV. A